

• General Description

The AGM30P10K combines advanced trench MOSFET technology with a low resistance package to provide extremely low R_{DS(ON)}

This device is ideal for load switch and battery protection applications.

• Features

- Advance high cell density Trench technology
- Low R_{DS(ON)} to minimize conductive loss
- Low Gate Charge for fast switching
- ■Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

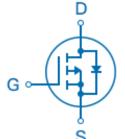
Product Summary

BVDSS	RDSON	ID
-100V	52mΩ	-30A

TO-252 Pin Configuration







Top View

Bottom View

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM30P10K	AGM30P10K	TO-252	330mm	16mm	2500

Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	-100	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25°C) (Note 1)	-30	Α
טו	Drain Current-Continuous(Tc=100℃)	-18	А
IDM (pluse)	Drain Current-Pulsed (Note 2)	-120	Α
	Maximum Power Dissipation(Tc=25℃)	50	w
PD	Maximum Power Dissipation(Tc=100℃)	20	W
EAS	Avalanche energy (Note 3)	156	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}$

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) ¹		50	°C/W
RθJC	Thermal Resistance Junction-Case ¹		2.5	°C/W



Table 3. Electrical Characteristics (Tj=25 ℃ unless otherwise noted)

Table 3. Electrical Characteristics (Tj=25 ℃ unless otherwise noted)						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off St	ates					
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=-250μA	-100			V
IDSS	Zero Gate Voltage Drain Current	VDS=-100V,VGS=0V			-1	μΑ
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=-250µA	-1.2		-2.2	V
gFS	Forward Transconductance	VDS=-5V,ID=-5A		20		S
RDS(on)	Drain-Source On-State Resistance	VGS=-10V, ID=-10A		52	61	mΩ
		VGS=-4.5V, ID=-5A		59	66	mΩ
Dynamic	Characteristics					
Ciss	Input Capacitance			4507		pF
Coss	Output Capacitance	VDS=-40V,VGS=0V ,F=1MHZ		97		pF
Crss	Reverse Transfer Capacitance	- ,1 - 11VII 12		15		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz		4.6		Ω
Switching	g Times					
td(on)	Turn-on Delay Time			49		nS
tr	Turn-on Rise Time	VGS=-10V,VDS=-50V,		71		nS
td(off)	Turn-Off Delay Time	ID=-10A,RGEN=4.5Ω		555	-	nS
tf	Turn-Off Fall Time			187		nS
Qg	Total Gate Charge			73		nC
Qgs	Gate-Source Charge	VGS=-10V, VDS=-50V, ID=-10A		17		nC
Qgd	Gate-Drain Charge	150 000, 15 1070		9.1		nC
Source-Drain Diode Characteristics						
ISD	Source-Drain Current(Body Diode)				-30	Α
VSD	Forward on Voltage	VGS=0V,IS=-10A			-1.2	V
trr	Reverse Recovery Time	Isd=-10A ,		32		ns
Qrr	Reverse Recovery Charge	dI/dt=100A/μs , TJ=25℃		49		nc

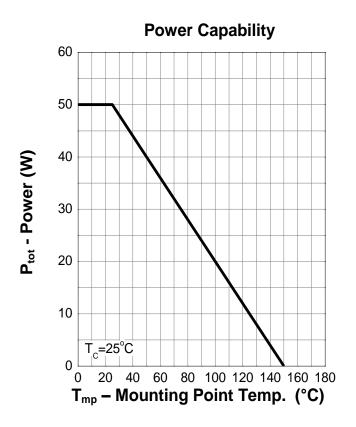
Notes 1. The maximum current rating is package limited.

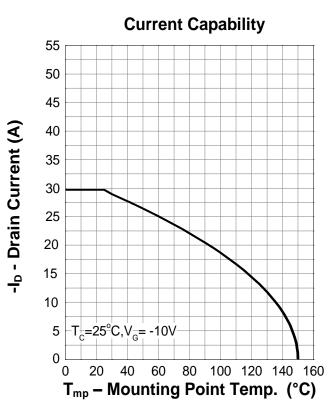
Notes 2. Repetitive Rating: Pulse width limited by maximum junction temperature

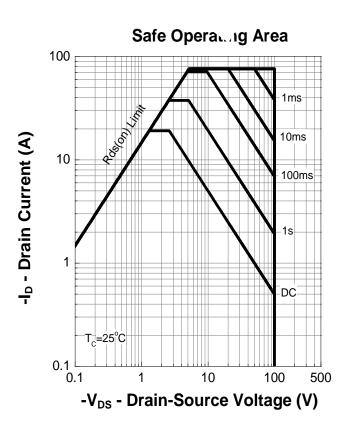
Notes 3.EAS condition: TJ=25 $^{\circ}$ C, VDD=-25V,Vgs=-10V,ID=-25A,L=0.5mH,RG=25ohm

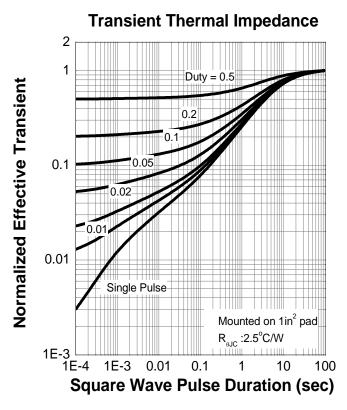


Typical Characteristics



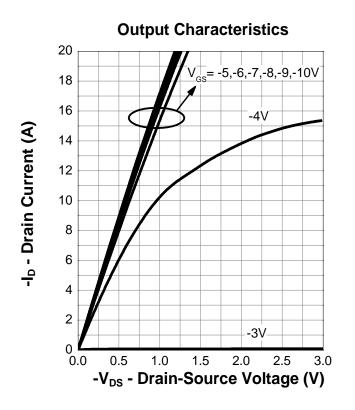


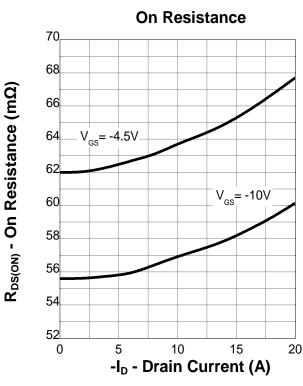


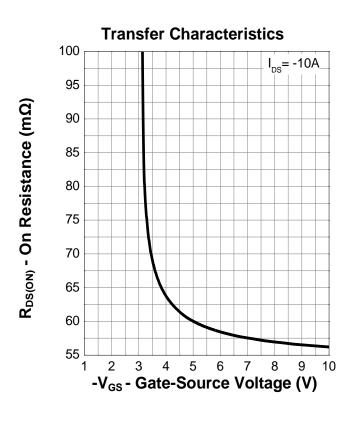


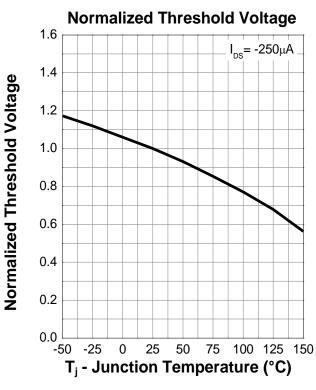


Typical Characteristics (cont.)



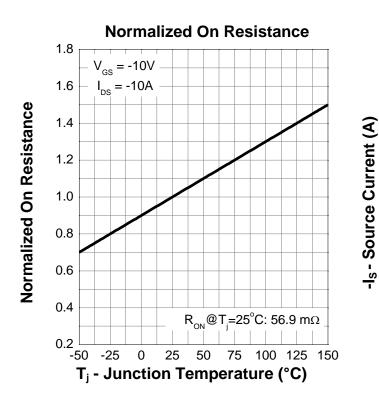


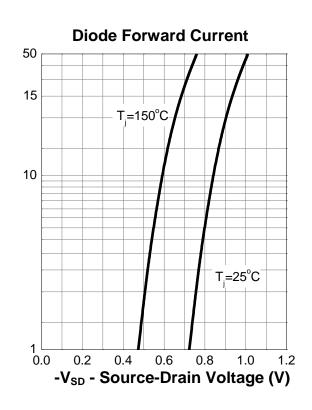


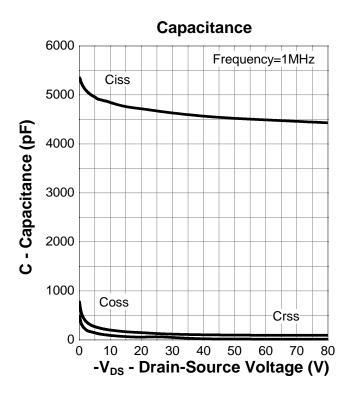


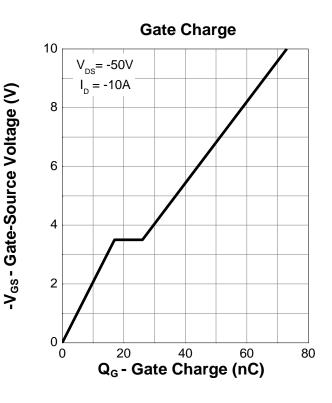


Typical Characteristics (cont.)



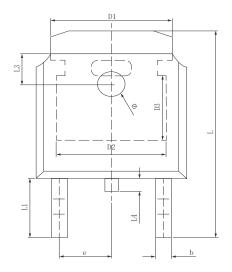


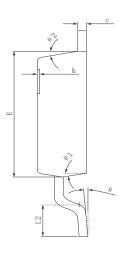


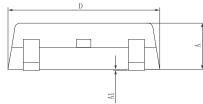


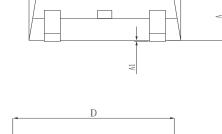


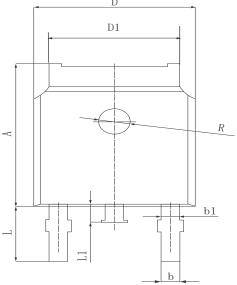
•Dimensions (TO-252)

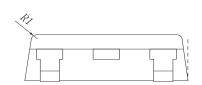


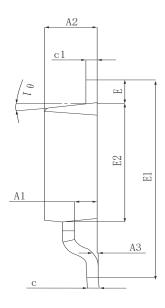


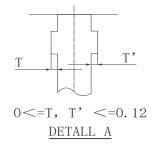






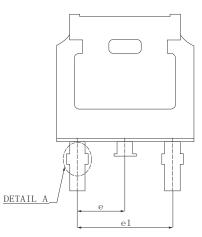






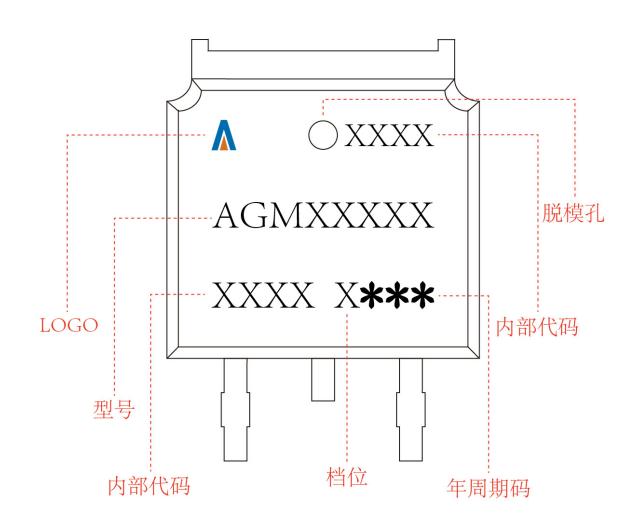
Olumoi.		MILLIMETER		
SYMBOL	MIN	Typ.	MAX	
A	2. 200	2.300	2.400	
A1	0.000		0.127	
b	0.640	0.690	0.740	
c(电镀后)	0.460	0.520	0.580	
D	6.500	6.600	6.700	
D1		5.334 REF		
D2		4.826 REF		
D3	3.166 REF			
Е	6.000	6.100	6.200	
е		2.286 TYP		
h	0.000	0.100	0.200	
L	9.900	10.100	10.300	
L1	2.888 REF			
L2	1.400	1.550	1.700	
L3	1.600 REF			
L4	0.600	0.800	1.000	
Ф	1.100	1.200	1.300	
θ	0°		8°	
θ 1	9° TYP			
θ2	9° TYP			

oramor.	MILLIMETER			
SYMBOL	MIN	NOM	MAX	
A	7.050	7. 100	7. 150	
A1	0.960	1.010	1.060	
A2	2.250	2. 300	2. 350	
A3	0.000	0.050	0.100	
b		0.760REF.		
b1		1.000REF.		
С	0.508REF.			
c1		0.508REF.		
D	6.550	6.600	6.650	
D1	5. 220	5. 320	5. 420	
Е	0.950	1.000	1.050	
E1	9.700	9. 900	10.100	
E2	6.050	6. 100	6.150	
е	2. 286BSC			
e1	4. 572REF.			
L	2.650	2.800	2.950	
L1	0.700	0.800	0.900	
θ 1	7° REF.			
R	1. 300REF.			
R1	0, 250REF.			





TO-252 Marking Instructions:





Disclaimer:

The information provided in this document is believed to be accurate and reliable. However, Shenzhen Core Control Source Electronics Technology Co., Ltd. does not assume any responsibility for the following consequences. Do not consider the use of such information or use beyond its scope.

The information mentioned in this document may be changed at any time without notice.

The products and information provided in this document do not infringe patents. Shenzhen Core Control Source Electronics Technology Co., Ltd. assumes no responsibility for any infringement of any other rights of third parties. The result of using such products and information.

This document is the third version issued on March 10th, 2024. This document replaces all previously provided information.

It is a registered trademark of Shenzhen Core Control Source Electronics Technology Co., Ltd.

Copyright © 2017 Shenzhen Core Control Source Electronics Technology Co., Ltd. all rights reserved.